SPECIFICATION FOR LCD MODULE

Model No. <u>TM0236AKFW</u>

Prepared by: Date: Checked by: Date: Verified by: Date: Approved by: Date:

TIANMA MICROELECTRONICS CO., LTD

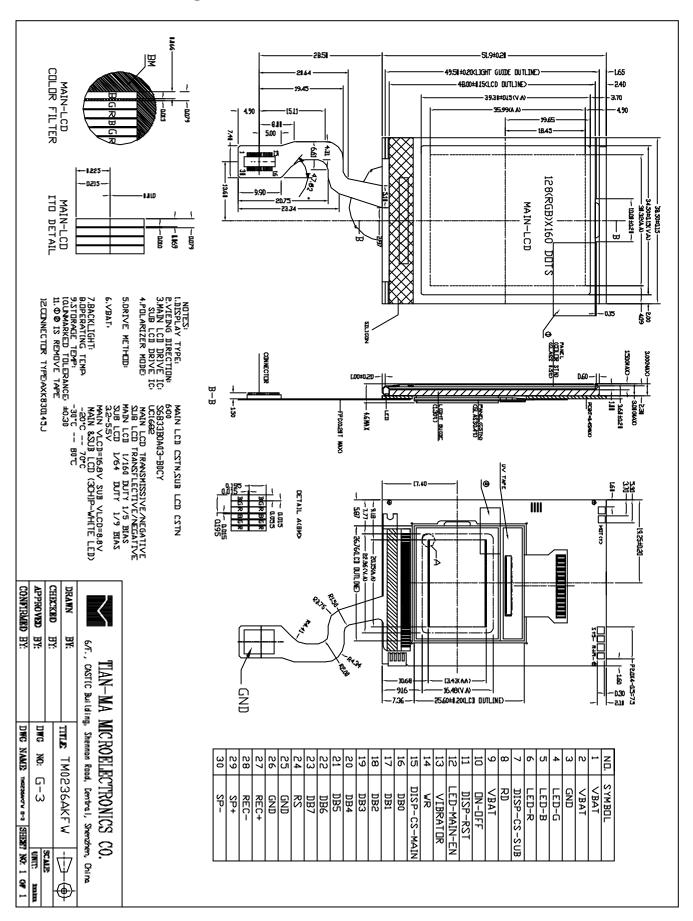
Rev. 20

REVISION RECORD

1 General Specifications:

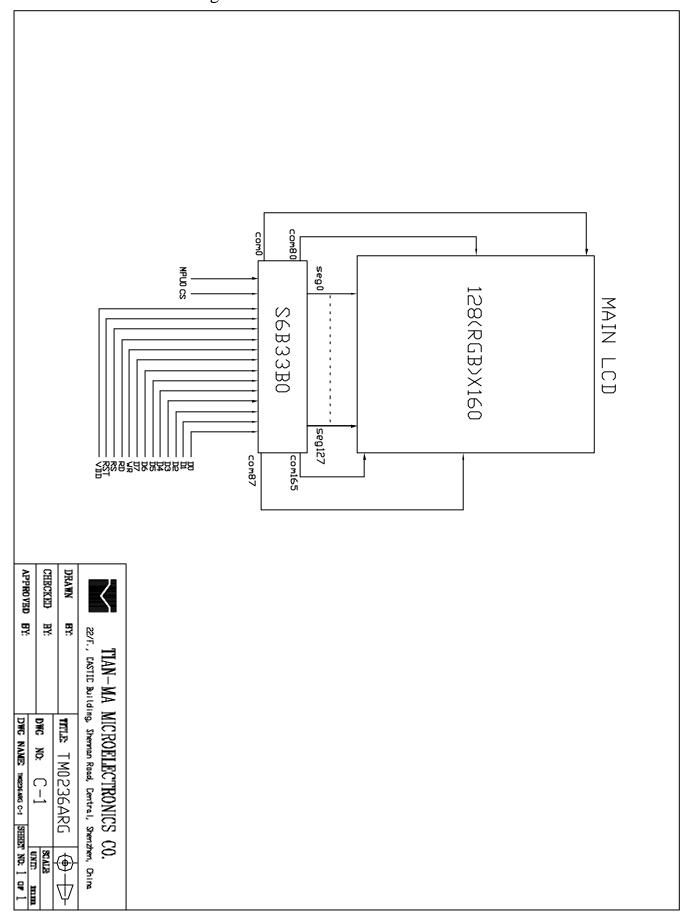
ITEM	CONTEN	TS	UNIT
	MAIN LCD	SUB LCD	
LCD TYPE	COLOR STN	COLOR STN	
LCD DUTY	1/160	1/64	
LCD BIAS	1/5	1/9	
VIEWING DIRECTION	6:00	6:00	O'CLOCK
GLASS AREA(WXH)	38.5X48. 0	26.76X25.6	MM
VIEWING AREA(WXH)	34. 5X39.3	22.96X16.48	MM
ACTIVE AREA(WXH)	30.32X35.99	20.15X13.43	MM
NUMBER OF DOTS	128(R+G+B)X160	96X64	
DOTS SIZE(WXH)	0.213X0.225	0.195X0.195	MM
DOT PITCH(WXH)	0.225X0.237	0.210X0.210	MM
CONTROLLER	S6B33B0A03-B0CY	UC1682xGAD-U0	
VDD	3.0		V
LCD OPERATING VOLTAGE	16.8	8.8	\mathbf{V}
OUTLINE DIMENSIONS	REFER TO OUTI	LINE DRAWING ON	
	NEXT PAGE		
BACKLIGHT	LED(WHITE)	LED(WHITE)	
OPERATING TEMPERAT	-20+70	-20+70	
STORAGE TEMPERATURE	-30+80	-30+80	
WEIGHT	TBD		
DATA TRANSFER	8 BIT PARALLEL		
POLARIZER MODE	TRANSMISSIVE	TRANSMISSIVE	
	/NEGATIVE	/NEGATIVE	

2. Outline Drawing

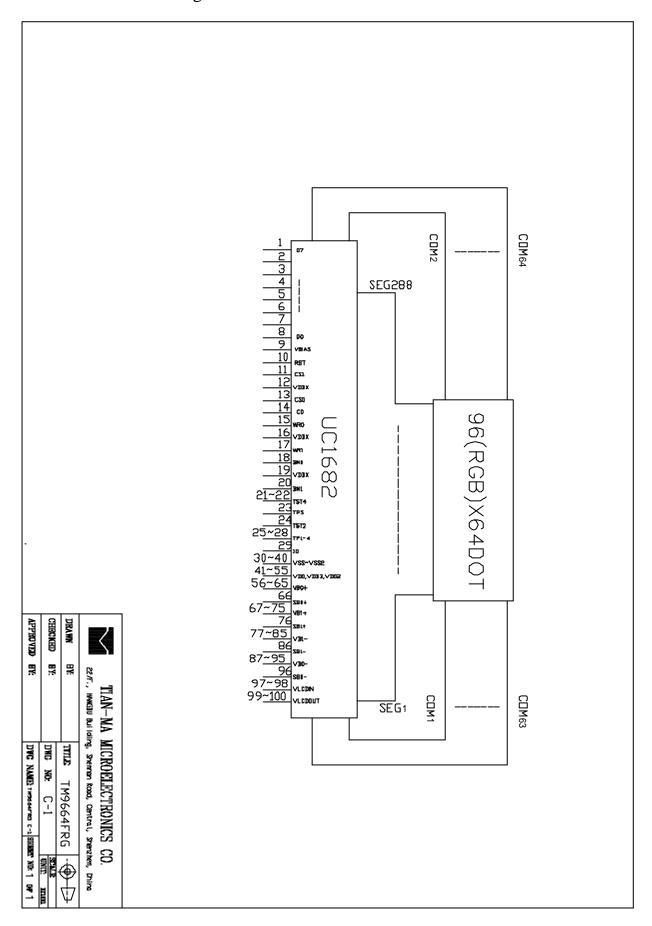


3. Circuit Block Diagram

3.1 Circuit Block Diagram Of Main LCD



3.2 Circuit Block Diagram Of Sub LCD



4 Absolute Maximum Ratings(Ta=25)

ITEM	SYMBOL	MIN	MAX	UNIT
Power supply	VBAT	3.0	5.0	V
voltage(1)				
Power supply	LCD_VCC	-0.3	4.0	V
voltage(2)				
Power supply	VLCD-GND	-0.3	20	V
Voltage for main LCD				
Logic signal Input	Vt	-0.3	LCD_VCC+0.3	V
voltage				
Operating temperature	Topr	-20	+70	
Storage temperature	Tst	-30	+80	

Notes:

- 1. If the module is used above these absolute maximum ratings. It may become permanently damaged. Using the module within the following electrical characteristic conditions are also exceeded, the module will malfunction and cause poor reliability.
- 2. LCD_VCC>GND must be maintained.

5. Electrical Specifications and Instruction Code (Vss=0v, Ta=25)

5.1 Electrical characteristics

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Supply voltage for logic	VBATT		3.2	3.8	4.5	V
Operation voltage for main LCD	VLCD1	25		16.8		V
Operation voltage for SUB LCD	VLCD2	25		8.8		V
Input voltage'H' Level	V_{IH}	LCD_VCC=3.0V	0.8VDD		LCD_VCC	V
Input voltage'L' Level	V_{IL}	LCD_VCC=3.0V	0		0.2VDD	V
Output voltage'H'level	$ m V_{OH}$	VDD=3.0V VDD=2.75V	0.8LCD_VCC		LCD_VCC	V
Output voltage'L'level	$V_{ m OL}$		0		0.2LCD_VCC	V
Current consumption for MAIN LCD normal operation	IDD1	LCD-VCC-GND=3.0V 1/160DUTY	-	1.2	2.0	mA
Current consumption for SUB LCD normal operation	IDD2	LCD-VCC-GND=3.0V 1/64DUTY		0.15	0.35	mA
Supply Voltage (LED)	$V_{ m LED}$			5		V
Supply current (LED)	I _{LED}			45	60.0	mA

5.2 Interface Signals

Pin NO.	Symbol	Function
1	VBAT	Power supply pin
2	VBAT	Power supply pin
3	GND	Ground pin
4	LED-G	Indication LED(GREEN)ON
5	LED-B	Indication LED(BLUE)ON
6	LED-R	Indication LED(RED)ON
7	DISP-CS-SUB	SUB chip selection input pin:Active"L"
8	RD	E is read enable clock input pin. When E="L",DB0~DB7 are
		in output status.
9	VBAT	Power supply pin.
10	ON-OFF	LDO ON/OFF
11	DISP-RST	Chip reset signal input pin:Active"L"
12	LED-MAIN-EN	LED backlight enable pin.when"H"the LED backlight is turn
		on.
13	VIBRTOR	Motor control pin.
14	WR	WR is write enabe clock input pin.DB0~DB7 are latched at
		the rising edge of the RW signal.
15	DISP-CS-MAIN	Main LCD(CSTN)chip selection input pin:Active"L".
16	DB0	
17	DB1	
18	DB2	
19	DB3	8bit Bi-directional data bus.
20	DB4	
21	DB5	
22	DB6	
23	DB7	
24	RS	Command/data select input pin.
		RS="L" input DB7~DB0 is control data;RS="L" input
		DB7~DB0 is display data.
25	GND	Ground pin.
26	GND	Ground pin.
27	REC+	Connect to REC.
28	REC-	Connect to REC.
29	SP +	Connect to speaker.
30	SP -	Connect to speaker.

5.3 Interface Timing Chart

Note: Please refer to SAMSUNG S6B33B0A / ULTRACHIP UC1682 / ANALOGIC AAT3113 data sheet for more details.

SAMSUNG S6B33B0A INTERFACE PROTOCOL

Read / Write Characteristics (8080-series MPU)

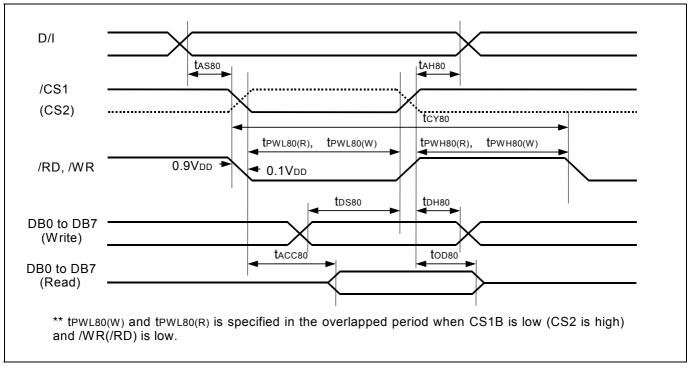


Figure 25. Parallel Interface (8080-series MPU) Timing Diagram

Table 17. AC Characteristics (8080-series Parallel Mode)

 $(VDD3 = 1.8 \text{ to } 3.3V, Ta = -30 \text{ to } +70^{\circ}C)$

		(VDD3 = 1.0 to 3.3 v, 1a = -30 to +70						
Item	Signal	Symbol	Condition	M	in.	Max.	Unit	
item	Signal	Symbol	Condition	3.3V	.3V 1.8V (3.3V/1.8) 0	
Address setup time Address hold time	D/I	t _{AS80} t _{AH80}		0 0	0 0	-	ns	
System cycle time		t _{CY80}		150	360	-	ns	
Pulse width low for write Pulse width High for write	WRB (WRB)	t _{PWLW}		50 30	100 75	-	ns	
Pulse width low for read Pulse width high for read	RDB (RDB)	t _{PWLR} t _{PWHR}		50 30	100 75	-	ns	
Data setup time Data hold time	DB0	t _{DS80} t _{DH80}		5 8	10 14	- -	ns	
Read access time Output disable time	to DB15	t _{ACC80} t _{OD80}	CL = 100 pF		tEWHR	60 / 120	ns	

NOTE: *1. The input signal rise time and fall time (tr, tf) is specified at 10 ns or less. (tr + tf) < (tcy80 - tpwlw - tpwhw) for write, (tr + tf) < (tcy80 - tpwlr - tpwhr) for read

9/25 R e v . 2 . 0

INSTRUCTION DESCRIPTION (S6B33B0)

Instruction Name	D/I	WRB	RDB	DB15 ~DB8	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Hex.	Parameter
Non Operation	0	0	1	*	0	0	0	0	0	0	0	0	00	
Oscillation Mode Set	0	0	1	*	0	0	0	0	0	0	1	0	02	1Byte
Driver Output Mode Set	0	0	1	*	0	0	0	1	0	0	0	0	10	1Byte
DC-DC Select	0	0	1	*	0	0	1	0	0	0	0	0	20	1Byte
Driving current & Bias Set	0	0	1	*	0	0	1	0	0	0	1	0	22	1Byte
DCDC Clock Division Set	0	0	1	*	0	0	1	0	0	1	0	0	24	1Byte
DCDC and AMP ON/OFF set	0	0	1	*	0	0	1	0	0	1	1	0	26	1Byte
Temperature Compensation Set	0	0	1	*	0	0	1	0	1	0	0	0	28	1Byte
Contrast Control(1)	0	0	1	*	0	0	1	0	1	0	1	0	2A	1Byte
Contrast Control(2)	0	0	1	*	0	0	1	0	1	0	1	1	2B	1Byte
Standby Mode OFF	0	0	1	*	0	0	1	0	1	1	0	0	2C	-
Standby Mode ON	0	0	1	*	0	0	1	0	1	1	0	1	2D	-
DDRAM Burst Mode OFF	0	0	1	*	0	0	1	0	1	1	1	0	2E	-
DDRAM Burst Mode ON	0	0	1	*	0	0	1	0	1	1	1	1	2F	-
Addressing Mode Set	0	0	1	*	0	0	1	1	0	0	0	0	30	1Byte
ROW Vector Mode Set	0	0	1	*	0	0	1	1	0	0	1	0	32	1Byte
N-line Inversion Set	0	0	1	*	0	0	1	1	0	1	0	0	34	1Byte
Entry Mode Set	0	0	1	*	0	1	0	0	0	0	0	0	40	1Byte
X-address Area Set	0	0	1	*	0	1	0	0	0	0	1	0	42	2Byte
Y-address Area Set	0	0	1	*	0	1	0	0	0	0	1	1	43	2Byte
RAM Skip Area Set	0	0	1	*	0	1	0	0	0	1	0	1	45	1Byte
Display OFF	0	0	1	*	0	1	0	1	0	0	0	0	50	-
Display ON	0	0	1	*	0	1	0	1	0	0	0	1	51	-
Specified Display Pattern Set	0	0	1	*	0	1	0	1	0	0	1	1	53	1Byte
Partial Display Mode Set	0	0	1	*	0	1	0	1	0	1	0	1	55	1Byte
Partial Display Start Line Set	0	0	1	*	0	1	0	1	0	1	1	0	56	1Byte
Partial Display End Line Set	0	0	1	*	0	1	0	1	0	1	1	1	57	1Byte
Area Scroll Mode Set	0	0	1	*	0	1	0	1	1	0	0	1	59	4Byte
Scroll Start Line Set	0	0	1	*	0	1	0	1	1	0	1	0	5A	1Byte
Set Display Data Length	Х	Х	Х	*	1	1	1	1	1	1	0	0	FC	1Byte
Display Data Write	1	0	1			<u>I</u>	Displa	ay Data	Write		<u>I</u>	<u> </u>	-	-
Display Data Read	1	1	0				Displa	ay Data	Read				-	-
Status Read	0	1	0	0				-	ata Rea	ad			-	-
Test Mode1	0	0	1	*	1	1	1	1	1	1	1	1	FF	-
Test Mode2	0	0	1	*	1	1	1	1	1	1	0	0	FE FD	-
Test Mode3 Test Mode4	0	0	1	*	1	1	1	1	1	0	1	1	FB	-
Test Mode5	0	0	1	*	1	1	1	1	1	0	1	0	FA	-
Test Mode6	0	0	1	*	1	1	1	1	1	0	0	1	F9	-

^{*:} Don' t care

Parameter: The number of parameter bytes that follows instruction data.

UC1682 AC CHARACTERISTICS

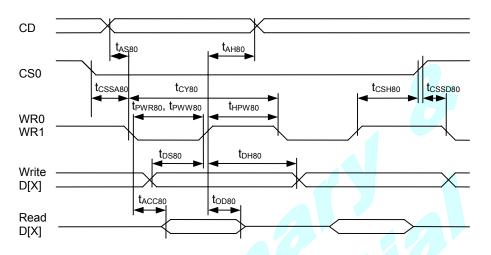


FIGURE 15: Parallel Bus Timing Characteristics (for 8080 MCU)

 $(V_{DD}=2.5V \text{ to } 3.3V, Ta=-30 \text{ to } +85^{\circ}C)$

Symbol	Signal	Description	Condition	Min.	Max.	Units
t _{AS80} t _{AH80}	CD	Address setup time Address hold time		0 10	_	ns
t _{CY80}		System cycle time 8 bits bus (read)		140	ı	ns
		(write) 4 bits bus (read)		128 128		
		(write)		128		
t _{PWR80}	WR1	Pulse width 8 bits (read)		65	1	ns
		4 bits		35		
t _{PWW80}	WR0	Pulse width 8 bits (write)		35	-	ns
		4 bits		35		
t _{HPW80}	WR0, WR1	High pulse width			-	ns
		8 bits bus (read)		65		
		(write)		35		
		4 bits bus (read)		35		
		(write)		35		
t _{DS80} t _{DH80}	D0~D7	Data setup time Data hold time		30 10	-	ns
t _{ACC80} t _{OD80}		Read access time Output disable time	C _L = 100pF	_ 10	50 50	ns
tssa80 tcssd80 t _{csh80}	CS1/CS0	Chip select setup time		10 10 20		ns

COMMAND TABLE

The following is a list of host commands supported by UC1680

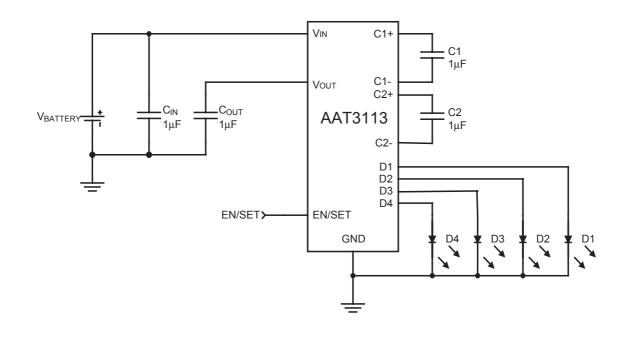
C/D: 0: Control, 1: Data W/R: 0: Write Cycle, 1: Read Cycle

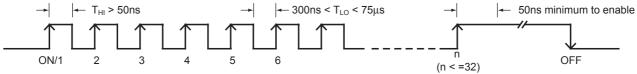
Useful Data bits– Don't Care

	Command	C/D	W/R	D7	D6	D5	D4	D3	D2	D1	D0	Action	Default
1	Write Data Byte	1	0	#	#	#	#	#	#	#	#	Write 1 byte	N/A
2	Read Data Byte	1	1	#	#	#	#	#	#	#	#	Read 1 byte	N/A
3	Get Status	0	1	-	MX	MY	WA	DE	WS	OD	OS	Get Status	N/A
4	Set Column Address LSB	0	0	0	0	0	0	#	#	#	#	Set CA[3:0]	0
4	Set Column Address MSB	0	0	0	0	0	1	-	#	#	#	Set CA[6:4]	0
5	Set Temp. Compensation	0	0	0	0	1	0	0	1	#	#	Set TC[1:0]	0
6	Set Panel Loading	0	0	0	0	1	0	1	0	#	#	Set PC[1:0]	01b
7	Set Pump Control	0	0	0	0	1	0	1	1	#	#	Set PC[3:2]	11b
8	Set Adv. Program Control	0	0	0	0	1	1	0	0	0	R	Set APC[R][7:0],	N/A
0	(double byte command)	0	0	#	#	#	#	#	#	#	#	R = 0, or 1	IN/A
9	Set Scroll Line LSB	0	0	0	1	0	0	#	#	#	#	Set SL[3:0]	0
9	Set Scroll Line MSB	0	0	0	1	0	1	#	#	#	# /	Set SL[7:4]	0
10	Set Row Address LSB	0	0	0	1	1	0	#	#	#	#	Set RA[3:0]	0
10	Set Row Address MSB	0	0	0	1	1	1	#	#	#	#	Set RA[7:4]	0
11	Set V _{BIAS} Potentiometer	0	0	1	0	0	0	0	0	0	1	Set PM[7:0]	83H
<u> </u>	(double-byte command)	0	0	#	#	#	#	#	#	#	#		
12	Set Partial Display Control	0	0	1	0	0	0	0	1	#	#	Set LC[9:8]	0: Disable
13	Set RAM Address Control	0	0	1	0	0	0	1	#	#	#	Set AC[2:0]	001b
14	Set Fixed Lines	0	0	1	0	0	1	#	#	#	#	Set FL[3:0]	0
15	Set Line Rate	0	0	1	0	1	0	0	0	#	#	Set LC[4:3]	10b
16	Set All-Pixel-ON	0	0	1	0	1	0	0	1	0	#	Set DC[1]	0
17	Set Inverse Display	0	0	1	0	1	0	0	1	1	#	Set DC[0]	0
18	Set Display Enable	0	0	1	0	1	0	1	1	#	#	Set DC[3:2]	10b
19	Set Color Mask	0	0	1	0	1	1	0	#	#	#	Set MSK[2:0]	0
20	Set LCD Mapping Control	0	0	1	1	0	0	0	#	#	#	Set LC[2:0]	0
21	Set Color Pattern	0	0	1	1	0	1	0	0	0	#	Set LC[5]	0 (BGR)
22	Set Color Mode	0	0	1	1	0	1	0	1	#	#	Set LC[7:6]	10b (65K)
23		0	0	1	1	1	0	0	0	1	0	System Reset	N/A
24	NOP	0	0	1	1	1	0	0	0	1	1	No operation	N/A
25	Set Test Control	0	0	1	1	1	0	0	1		Т	For testing only.	N/A
23	(double byte command)	0	0	#	#	#	#	#	#	#	#	Do not use.	IN/A
26	Set LCD Bias Ratio	0	0	1	1	1	0	1	0	#	#	Set BR[1:0]	11b (12)
27	Reset Cursor Update Mode	0	0	1	1	1	0	1	1	1	0	AC[3]=0, CA=CR	AC[3]=0
28	Set Cursor Update Mode	0	0	1	1	1	0	1	1	1	1	AC[3]=1, CR=CA	AC[3]=1
29	Set COM End	0	0	1	1	1	1	0	0	0	1	Set CEN[7:0]	159
29	GEL COM ENG	0	0	#	#	#	#	#	#	#	#	Set CEN[7.0]	108
30	Set Partial Display Start	0	0	1	1	1	1 #	0	0	1	0 #	Set DST[7:0]	0
		0	0	# 1	# 1	# 1	1	# 0	# 0	# 1	1		
31	Set Partial Display End	0	0	#	#	#	#	#	#	#	#	Set DEN[7:0]	159
										•			

Application Circuits

Typical AAT3113 Application Circuit:





Enable / Disable / LED Brightness Level Set Data Input

Current Levels (mA)

Code	20 mA max				
1	0.549				
2	0.627				
3	0.706				
4	0.784				
5	0.863				
6	1.020				
7	1.098				
8	1.255				
9	1.412				
10	1.569				
11	1.804				
12	1.961				
13	2.275				
14	2.510				
15	2.824				
16	3.137				

Code	20 mA max
17	3.529
18	4.000
19	4.471
20	5.020
21	5.647
22	6.353
23	7.059
24	7.922
25	8.941
26	10.039
27	11.216
28	12.627
29	14.118
30	15.843
31	17.804
32	20.000

6. Optical Characteristics

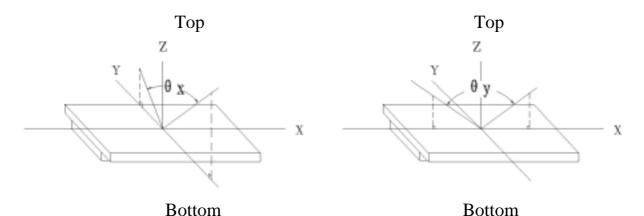
6.1 Optical Characteristics

V_{LCD}=16.8V Ta=25

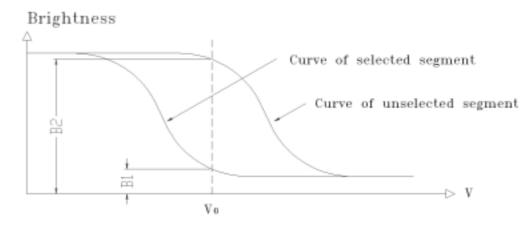
Iten	Item Symbol			Condition	1	Min.	Тур.	Max.	Unit	
				y=0 °	MAIN	_)			
Viewing Angle	X	Cr≥2	y-0	SUB	_	6036		Deg		
		C1 <u>~</u> 2	_x =0 °	MAIN	-	30+45	5	Deg		
		у		x-0	SUB	_	4240			
Contrast Ratio C1		Cr		$_{x}=0$ ° $_{y}=0$ °		30	40	60	-	
Response on		Ton	x=0 °			_	-	180	ms	
Time	Turn off	Toff		y=0 °		70	-	90		
	White	X		x=0 °		-	0.30	-	-	
	Willie	у		y=0 °		-	0.36	-	-	
Color	Red	X		x=0 °		-	0.53	1	-	
Of CIE	Red	у		y=0 °		-	0.37	1	-	
Coord- Inate	Green	X		$_{x}=0$ °		-	0.31	-	-	
	Green	у		y=0 °		-	0.51	-	-	
	Dluc	X		_x =0 °		-	0.16	-	-	
Blue		у		y=0 °		_	0.18	-	-	

6.2 Definition of Optical Characteristics

6.2.1 Definition of Viewing Angle



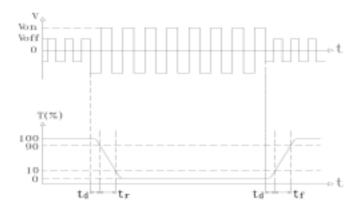
6.2.2 Definition of Contrast Ratio



Contrast Ratio = $B2/B1 = \frac{\text{unselected state brightness}}{\text{selected state brightness}}$

Measuring Conditions:

1) Ambient Temperature: 25 ; 2) Frame frequency: 70.0Hz 6.2.3 Definition of Response time



Turn on time: $t_{o\,n}=t_{d}+t_{r}$ Turn off time: $t_{o\,f\,f}=t_{d}+t_{f}$ Measuring Condition:

- 1) Operating Voltage:MAIN-LCD 16.8V SUB-LCD 8 . 8 V
- 2) Frame frequency: 70.0Hz

6.3 Brightness Characteristic

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Brightness	Вр	Ta=25 ±3	100	-	-	cd/m ²
Uniformity	Вр	30-80%RH	7 5	-	-	%

Note:

- 1. The data is measured after LED are turned on for 5 minutes.
- 2. Testing conditions LED: VLED =5.0 V (DC)
 LCD: All dots are on (White color)
- 3. Brightness in the center of the LCD panel.
- 4. Definition of Uniformity (Bp)

Bp = Bp (Min.) / Bp (Max.) X 100 (%)

Bp (Max.) = Maximum brightness in 9 measurement spots

Bp (Min.) = Minimum brightness in 9 measurement spots

7. Reliability

7. Reliability

7.1 Content of Reliability Test

Ta=25

No.	Test Item	Content of Test	Test condition		
1	High Temperature Storage	Endurance test applying the high storage temperature for a long time	80 ±2 240H Restore 4H at 25		
2	Low Temperature Storage	Endurance test applying the low storage temperature for a long time	-30 ±2 240H Restore 4H at 25		
3	High Temperature Operation	Endurance test applying the electric stress (voltage & current) and the thermal stress to the element for a long time	70 ±2 240H Restore 4H at 25		
4	Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time	-20 ±2 240H Restore 4H at 25		
5	High Temperature /Humidity Storage	Endurance test applying the high temperature and high humidity storage for a long time	60 ±2 90%RH 240H Restore 4H at 25		
6	Temperature Cycle	Endurance test applying the low and high temperature cycle -30 25 80 25 30min 5min 30min 5min 1 cycle	-30 /80 10 cycles Restore 4H at 25		
7	Vibration Test (package state)	Endurance test applying the vibration during transportation	10Hz~150Hz, 100m/s ² , 120min		
8	Shock Test (package state)	Endurance test applying the shock during transportation	Half- sine wave, 300m/s ² , 18ms		
9	Atmospheric Pressure Test	Endurance test applying the atmospheric pressure during transportation by air	25kPa 16H Restore 2H		

7.2 Failure Judgment Criterion

Criterion Item			To	est i	Iter	n N	0.			Failure Indoorset Critorian
		2	3	4	5	6	7	8	9	Failure Judgement Criterion
Basic Specification	1	V	V	V	V	V	V	√	√	Out of the basic Specification
Electrical specification	1	V	V	V	7					Out of the electrical specification
Mechanical Specification							1	V		Out of the mechanical specification
Optical Characteristic	1	1	1	1	V	1			√	Out of the optical specification
Note	For test item refer to 8.1									
Remark	Basic specification = Optical specification + Mechanical specification									

8. Quality Level

Examination or Test	At T _a =25	Inspection					
	(unless otherwise stated)	Min.	Min. Max. Unit		IL	AQL	
External Visual Inspection	Under normal illumination and eyesight condition, the distance between eyes and LCD is 25cm.	See	e Append	II	Major 1.0 Minor 2.5		
Display Defects	Under normal illumination and eyesight condition, display on inspection.	See	e Append	lix B	II	Major 1.0 Minor 2.5	

Note: Major defects: Open segment or common, Short, Serious damages, Leakage

Miner defects: Others

Sampling standard conforms to GB2828

9. Precautions for Use of LCD Modules

- 9.1 Handling Precautions
- 10.1.1 The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.
 - 9.1.2 If the display panel is damaged and the liquid crystal substance inside it leaks out, be sure not to get any in your mouth, if the substance comes into contact with your skin or clothes, promptly wash it off using soap and water.
 - 9.1.3 Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
 - 9.1.4 The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.
 - 9.1.5 If the display surface is contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If still not completely clear, moisten cloth with one of the following solvents:
 - Isopropyl alcohol
 - Ethyl alcohol

Solvents other than those mentioned above may damage the polarizer. Especially, do not use the following:

- Water
- Ketone
- Aromatic solvents
- 9.1.6 Do not attempt to disassemble the LCD Module.
- 9.1.7 If the logic circuit power is off, do not apply the input signals.
- 9.1.8 To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
 - a. Be sure to ground the body when handling the LCD Modules.
 - b. Tools required for assembly, such as soldering irons, must be properly ground.
 - c. To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.
 - d. The LCD Module is coated with a film to protect the display surface. Be care when peeling off this protective film since static electricity may be generated.

- 9.2 Storage precautions
- 9.2.1 When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps.
- 9.2.2 The LCD modules should be stored under the storage temperature range.

 If the LCD modules will be stored for a long time, the recommend condition is:

Temperature: $0 \sim 40$

Relatively humidity: 80%

- 9.2.3 The LCD modules should be stored in the room without acid, alkali and harmful gas.
- 9.3 The LCD modules should be no falling and violent shocking during transportation, and also should avoid excessive press, water, damp and sunshine.

Appendix A

Inspection items and criteria for appearance defects

Items	Contents	Criteria					
Leakage		Not permitted					
Rainbow		According to the limit specimen					
	Wrong polarizer attachment	Not permitted	l				
Polarizer	Bubble between	Not counted		Max. 3 defects al	llowed		
	polarizer and glass	φ<0.3mm		0.3mm \$\phi\$ 0.51	nm		
	Scratches of polarizer	According to the limit specin		mit specimen			
Black spot		Not counted	Max	Max. 3 spots allowed			
(in viewing area)	İ	X<0.2mm	0.2m	Max. 3			
	α	X=(a+b)/2			spots (lines)		
Black line (in viewing		Not counted	Max. 3 lines allowed		allowed		
area)	b	a<0.02mm	0.02mm a 0.05mm b 2.0mm				
Progressive cracks		Not permitted	l		,		

Appendix A

Inspection item and criteria for appearance defects (continued)

Contents	Criteria			Criteria		
Cracks on pads	a	b	ı	С	Max. 2	
	3mm	W	V/5	T/2	cracks	
b + A	2mm	V	V/5	T/2 <c<t< td=""><td>anowed</td><td></td></c<t<>	anowed	
Cracks on contact side	a			b		
	3m	m		T/2		
	2m	2mm T/2 <b<t< td=""><td>Γ/2<b<t< td=""><td></td><td>Mov. 5</td></b<t<></td></b<t<>		Γ/2 <b<t< td=""><td></td><td>Mov. 5</td></b<t<>		Mov. 5
	C shall be not reach the seal area				Max. 2 cracks	Max. 5 cracks allowed
Cracks on non-contact side	a b		b	allowed		
	3m	m		T/2		
	2mm		T/2 <b<t< td=""><td></td><td></td></b<t<>			
- SW -	C 0.5mm					
2"	d SW/3					
Corner cracks					Max. 3 cracks allowed	
	Cracks on contact side Cracks on non-contact side	Cracks on pads 3mm 2mm Cracks on contact side Cracks on non-contact side Cracks on non-contact side a 3mi 2mi C shall b area C 0.5mi d SW/3 Corner cracks	Cracks on pads a b 3mm W 2mm W Cracks on contact side a 3mm 2mm C shall be not area Cracks on non-contact side a 3mm C shall be not area Cracks on non-contact side a 3mm C shall be not area Cracks on shall be not area 3mm C shall be not area	Cracks on pads a b 3mm W/5 2mm W/5 Cracks on contact side a 3mm 2mm C shall be not reactarea Cracks on non-contact side a 3mm C shall be not reactarea Cracks on son-contact side a 3mm C shall be son reactarea C 0.5mm d SW/3 Corner cracks e<2.0mm²	Cracks on pads a b c 3mm W/5 T/2 2mm W/5 T/2 Cracks on contact side a b 3mm T/2 2mm T/2 C shall be not reach the seal area 3mm T/2 2mm T/2 <	Cracks on pads a b c 3mm W/5 T/2 2mm W/5 T/2 <c<t 2="" 2<b<t="" 2mm="" 3="" 3mm="" a="" allowed="" amax.="" area="" b="" be="" c="" contact="" cracks="" cracks<="" non-contact="" not="" on="" reach="" seal="" shall="" side="" t="" td="" the=""></c<t>

Appendix B
Inspection items and criteria for display defects

Items	Items Contents		Criteria				
Open segment or open common		Not permitted					
Short			Not permitted				
Wrong viewing angle			Not permitted				
Contrast radi	o unever	1	According to	the limit specimen			
Crosstalk			According to	the limit specimen			
	,	h tan	Not counted	Max.3 dots allowed			
	KS		X<0.1mm	0.1mm X 0.2mm			
Pin holes		X=(a+b)/2	Max.3 dots				
and cracks in segment		Not counted	Max.2 dots allowed	allowed			
(DOT)		A<0.1mm	0.1mm A 0.2mm D<0.25mm				
Black spot	ot.		Not counted	Max.3 spots allowed			
(in viewing area)			X<0.1mm	0.1mm X 0.2mm			
arca)	<u> </u>		X=(a+b)/2	Max.3 spots			
Black line			Not counted	Max.3 lines allowed	(lines) allowed		
(in viewing area)	b b		a<0.02mm	0.02mm a 0.05mm b 0.5mm			

Appendix B
Inspection items and criteria for display defects (continued)

Items	Content	Criteria			
	10	Not counted	Max. 2 defects allowed		
		x < 0.1mm	0.1mm x 0.2mm		
		x=(a+b)/2			
	*			Max.3	
	D-711-a	Not counted	Max. 1 defects allowed	defects allowed	
Transformation of segment		a < 0.1mm	0.1mm a 0.2mm D>0		
		Max.2 defects 0.8W a 1.2 a=measured va W=nominal va	W alue of width		